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Epitaxial growth and characterization of 4H-SiC for detection applications

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di CATANIA



Summary

Introduction

- SiC physical properties
- Epitaxial Growth

4H-SiC applications

- Particles detection

Characterization

- Photoluminescence maps
- Raman spectra
- Carrier Lifetime

Influence of the defects on carrier lifetime

- Study of Different types of SF defects

Conclusion

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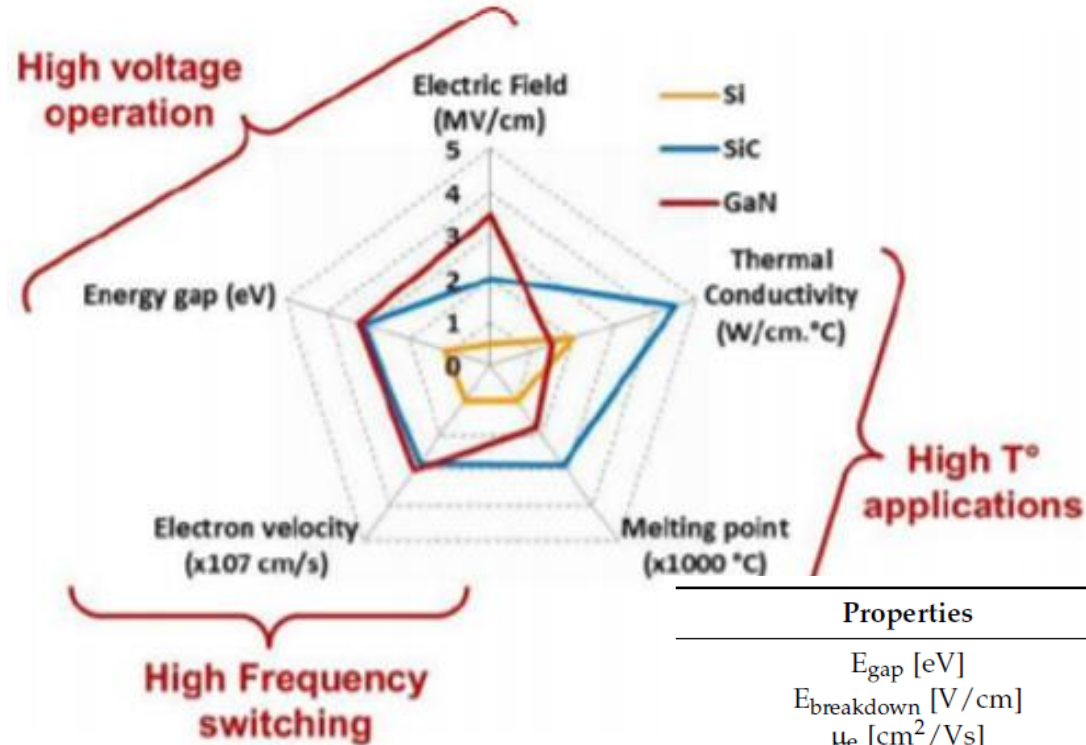
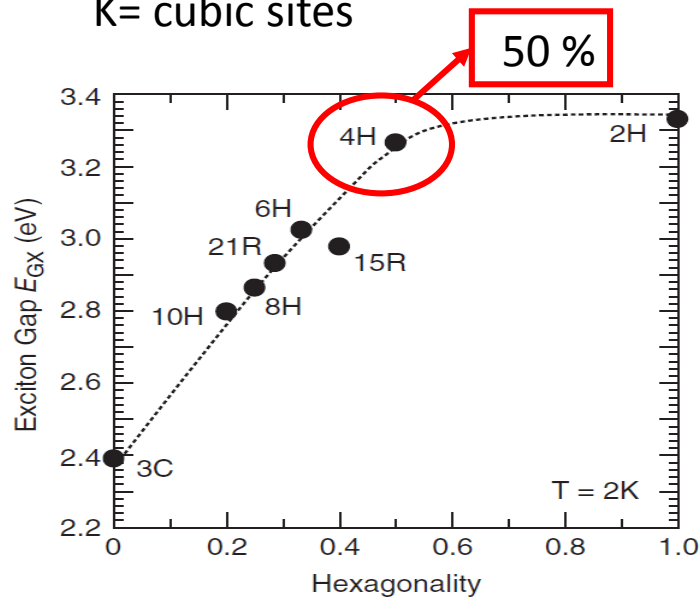
Introduction

SiC physical properties

$$H(\%) = (h/h + k) * 100$$

h= hexagonal sites

K= cubic sites



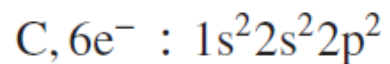
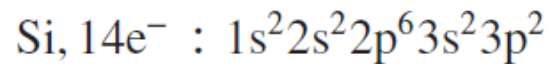
Other properties

- Transparency to visible light
- Ultraviolet (UV) wavelength absorption
- Radiation hardness
- Biocompatibility...

Properties	4H-SiC	Si
E_{gap} [eV]	3.23	1.12
$E_{breakdown}$ [V/cm]	$3-4 \times 10^6$	3×10^5
μ_e [cm^2/Vs]	800	1450
μ_h [cm^2/Vs]	115	450
$V_{saturation}$ [cm/s]	2×10^7	0.8×10^6
Z	14/6	14
ϵ_r	9.7	11.9
E-h energy [eV]	7.6-8.4	3.6
Density [g/cm^3]	3.22	2.33
Displacement E [eV]	30-40	13-15
Thermal Conductivity [W/cm·K]	4.9	1.5

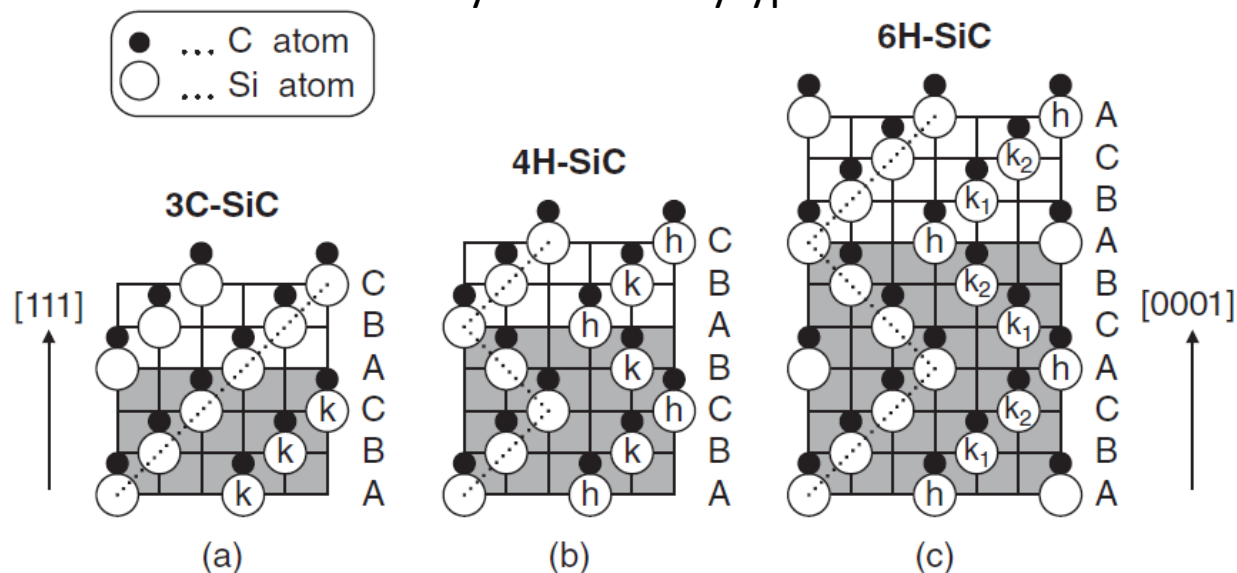
Introduction

SiC physical properties



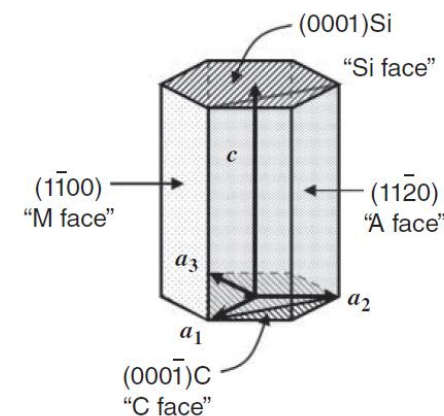
Crystallographic characteristics of the SiC polytypes

Crystalline Polytypes



Kimoto et al., *Silicon Carbide Epitaxy*, edited by F. La Via (Research Signpost, 2012)

Polytype	Unit cell sequence	Lattice parameters (nm)	Inequivalent sites	Structure	Hexagonality rate (%)
2H-SiC	AB	a=0.3081 c=0.5048	1	hexagonal (wurtzite)	100
3C-SiC	ABC	a=0.4349 a=0.3081 c=0.75	1	cubic(zincblende) hexagonal (hcp)	0
4H-SiC	ABAC	a=0.3081 c=1.08	2	Hexagonal closed packed (hcp)	50
6H-SiC	ABCACB	a=0.3081 c=1.501	3	hexagonal (hcp)	33
15R-SiC	ABCACBCABACBCB	a=0.3081 c=3.77	5	rhombohedral	40



Introduction

Epitaxial growth

Horizontal hot-wall reactor



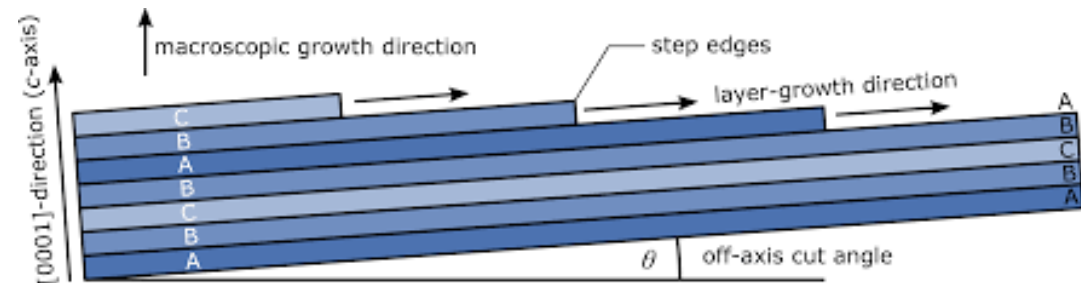
Substrate:

- 4H-SiC (0001)
- Si face
- n-type ($\cong 10^{18} \text{ cm}^{-3}$)
- Off-axis ($\cong 4^\circ$)

Silicon Carbide Epitaxy, edited by F. La Via (Research Signpost, 2012)

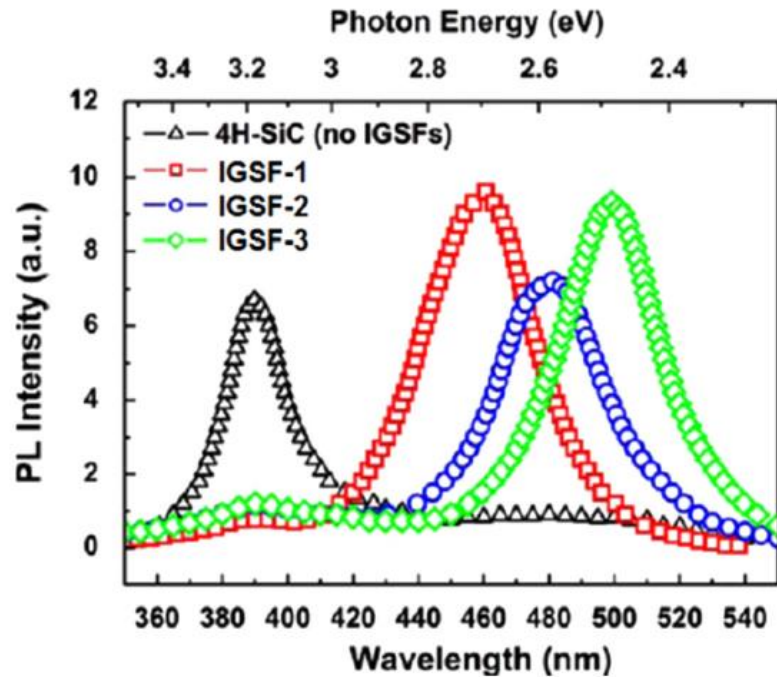
Parameters:

- Si/C
- T (1550-1650°C)
- Dopant gas control
- Hydrogen flow (150 slm)
- Chloride compounds
- Low pressure regime (100 mbar)



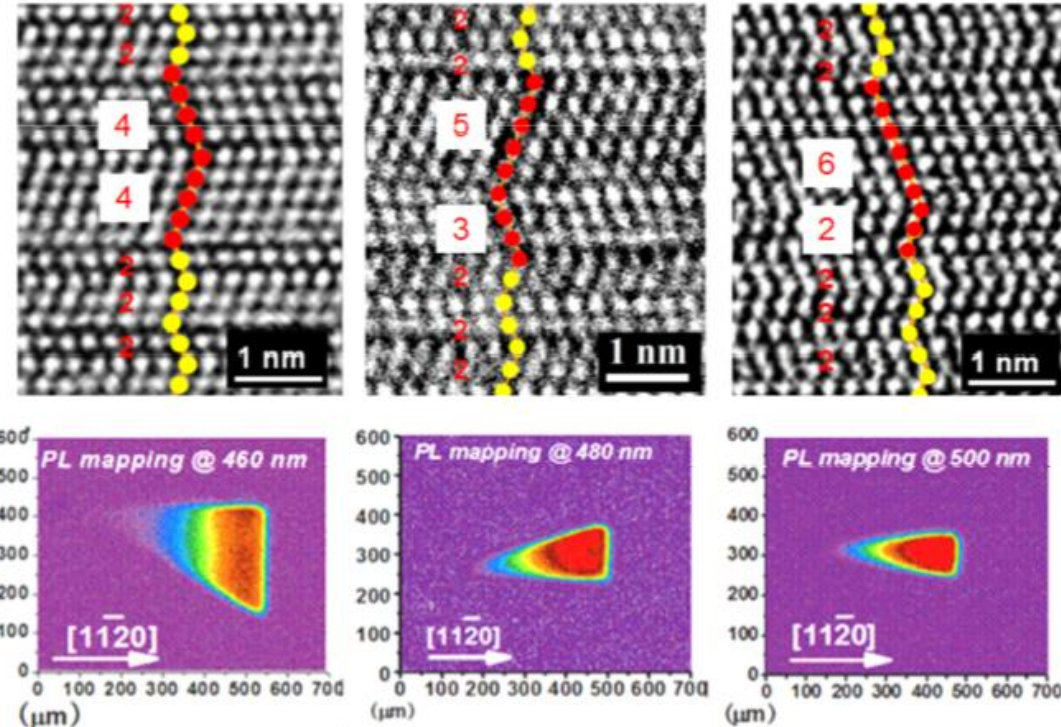
Introduction

Epitaxial growth



Kimoto et al., Silicon Carbide Epitaxy, edited by F. La Via (Research Signpost, 2012), Chap. 6.

Stacking faults



Kimoto et al., Silicon Carbide Epitaxy, edited by F. La Via (Research Signpost, 2012)

Killer defects →

- Carrier lifetime
- + Leakage current

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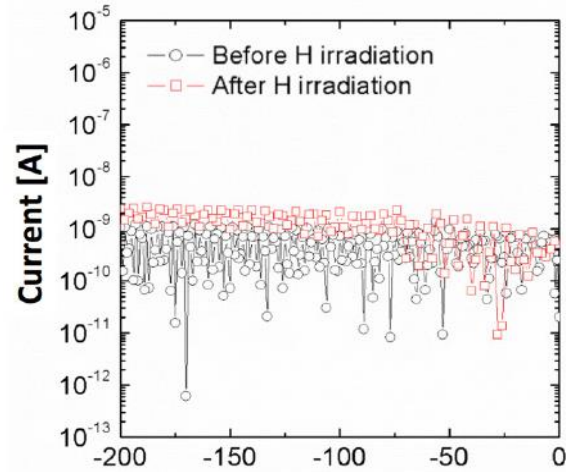
Influence of the defects on carrier lifetime

- Study of Different types of SF defects

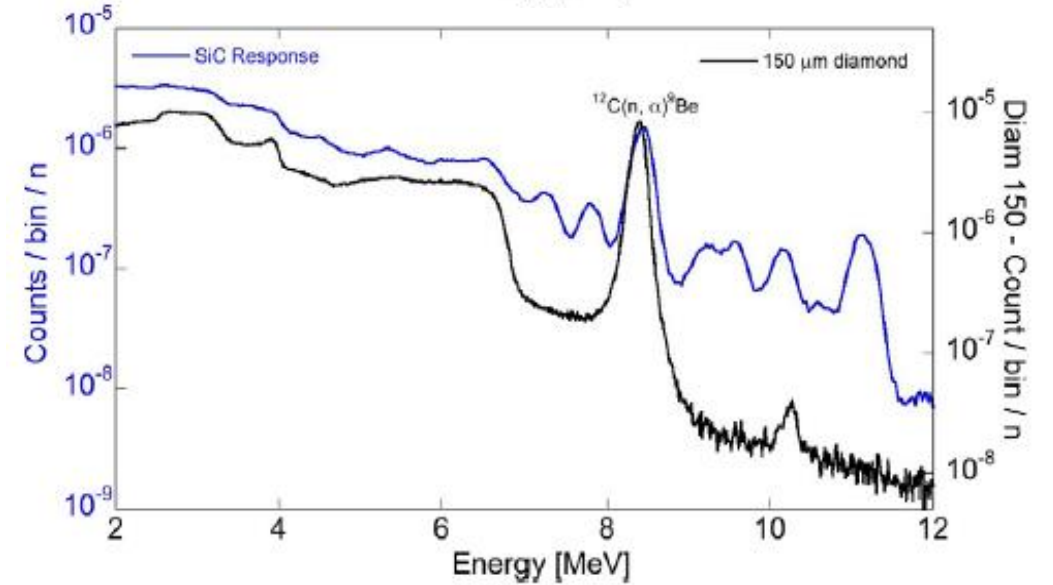
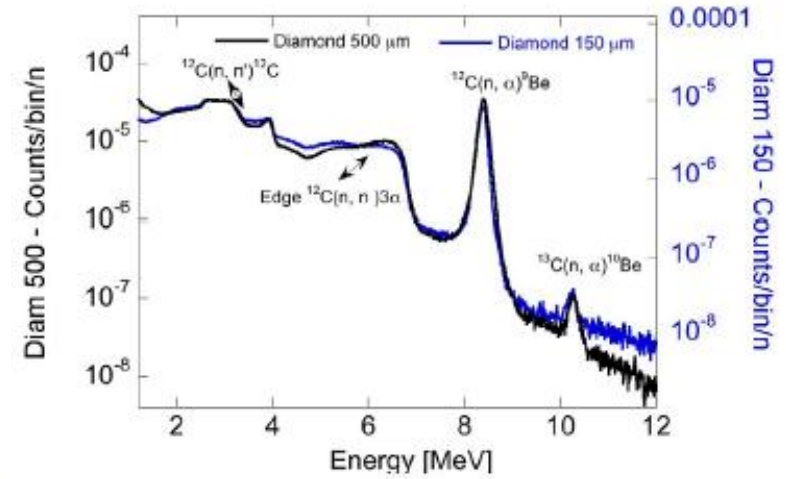
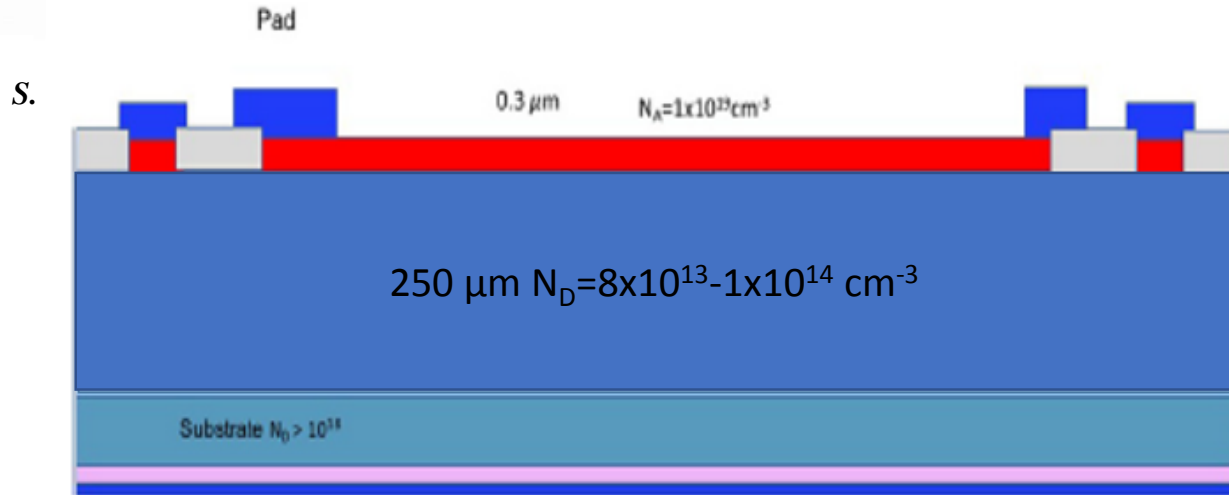
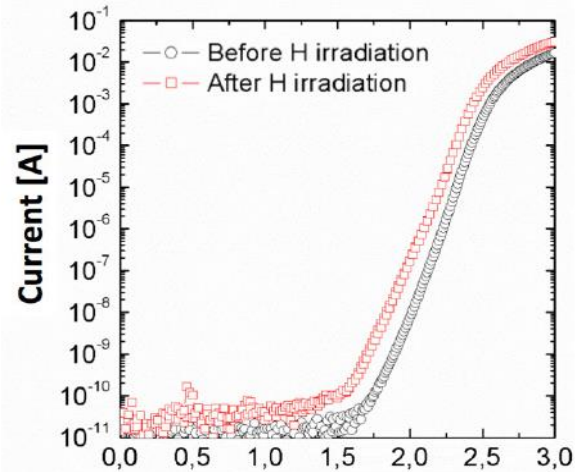
Conclusion

4H-SiC applications

Particles detection



Radiation Hardness

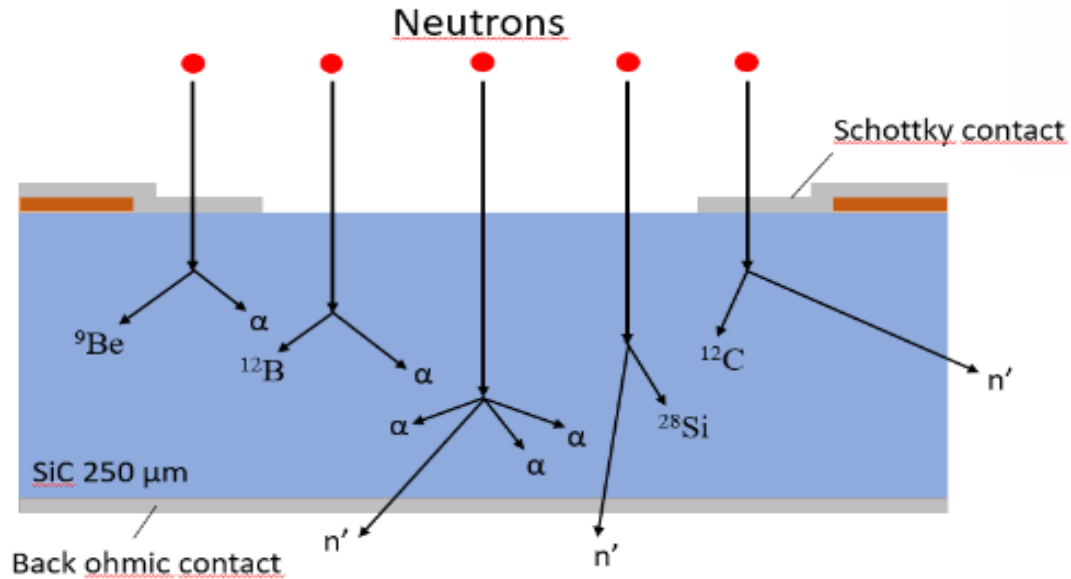


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bai M. et al., New thick silicon carbide detectors: Response to 14 MeV neutrons and comparison with single-crystal diamonds. Nucl. Instrum. Methods Phys. Res. Nuclear Inst. and Methods in Physics Research, A 946 (2019) 162637.

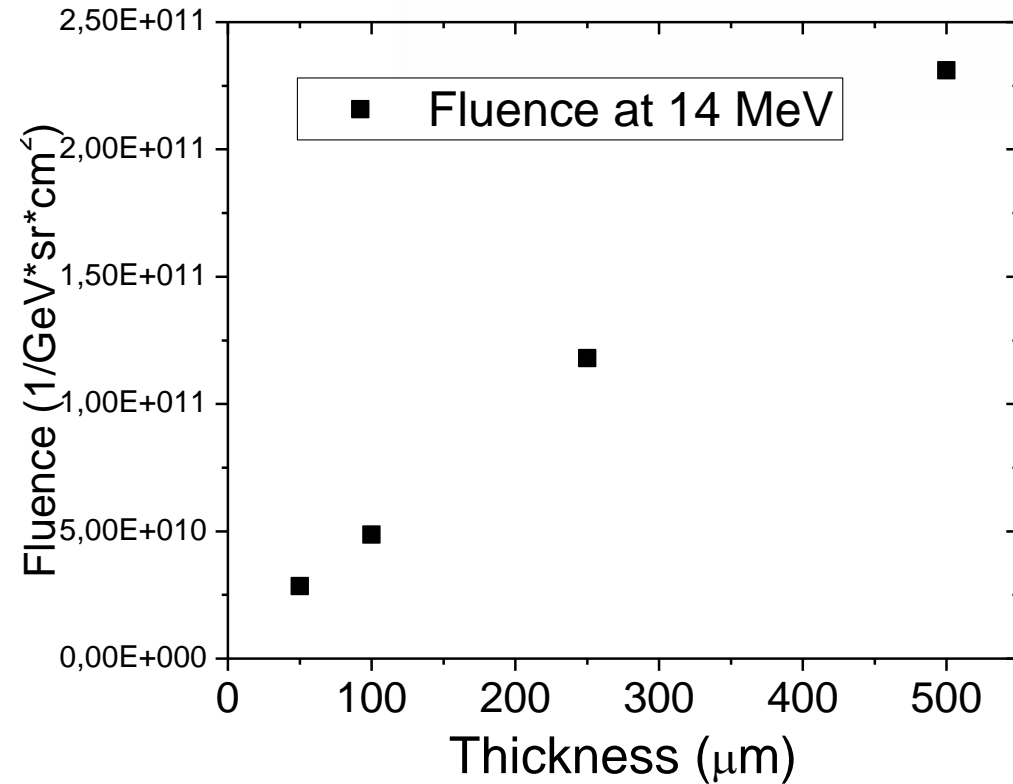
4H-SiC applications

Fluence calculation with Fluka



These reactions are triggered by interaction of 14 MeV fast-neutrons with Si and C nuclei.

Deuterium-tritium neutron generator.



Detectors yeald

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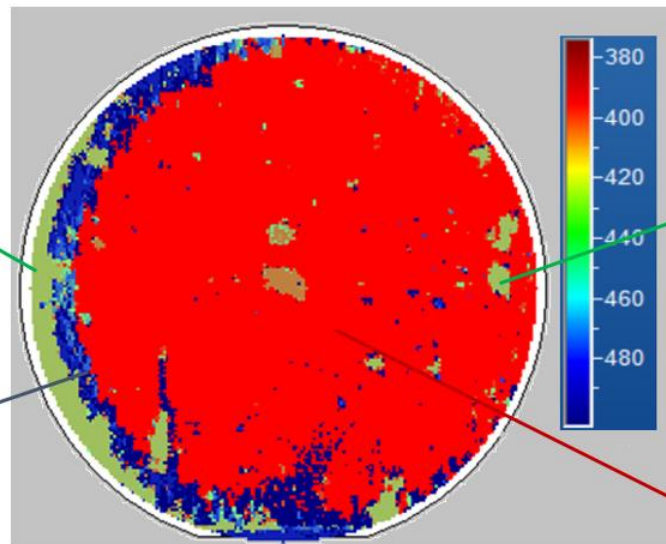
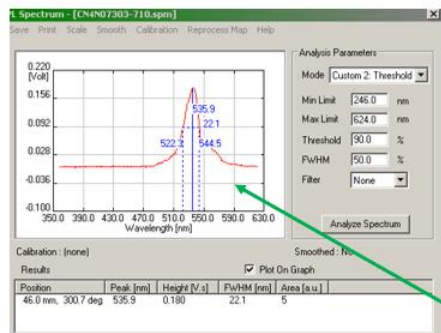
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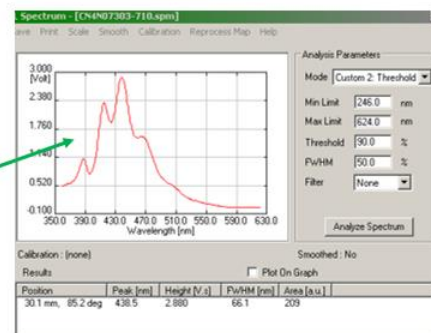
Characterization

Photoluminescence maps

3C PL signal

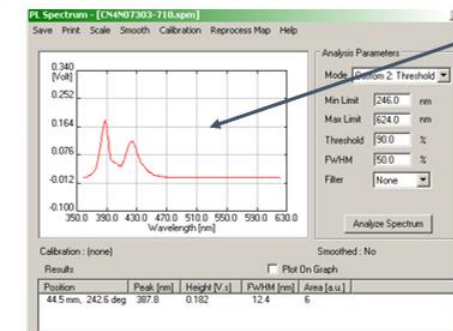


Additional PL signals

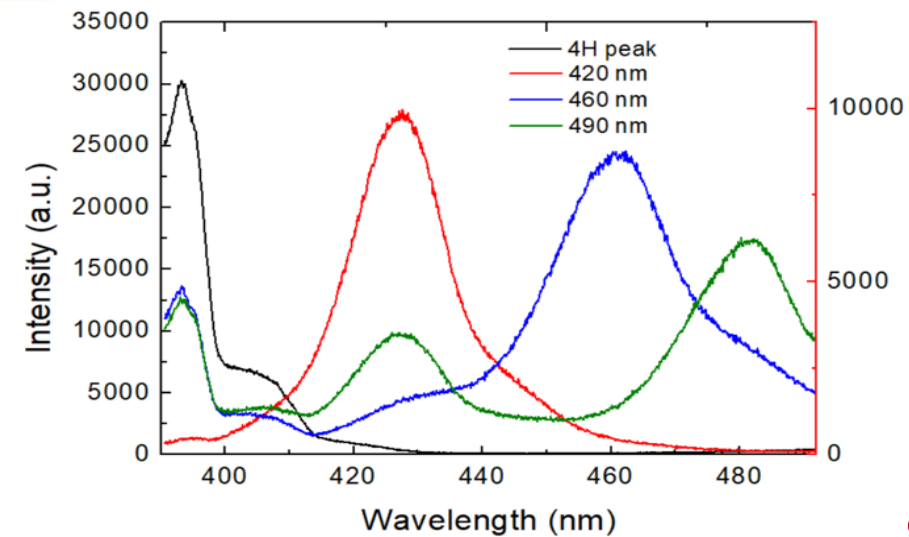
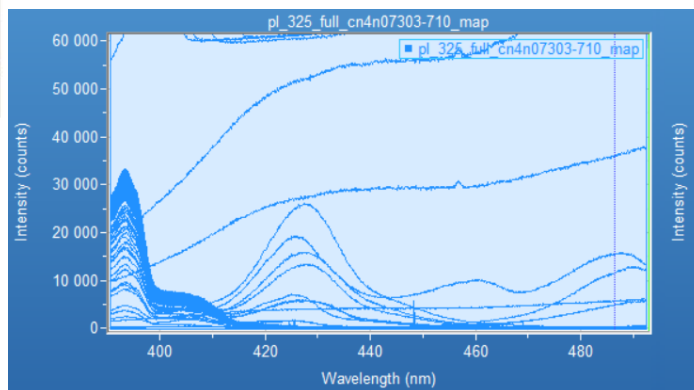
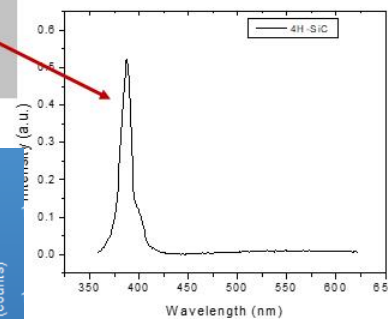


- 390 nm Band-to-band peak
- 430 nm bar shaped or SSF
- 460 nm SF (4,4)
- 490 nm SF (5,3)

Additional PL signal @420nm

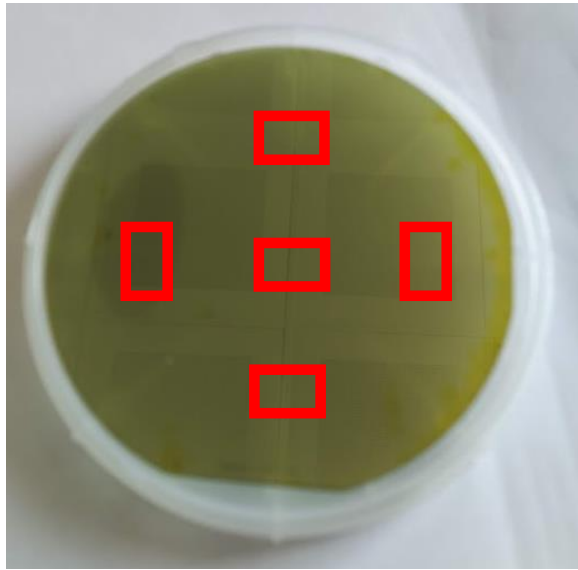
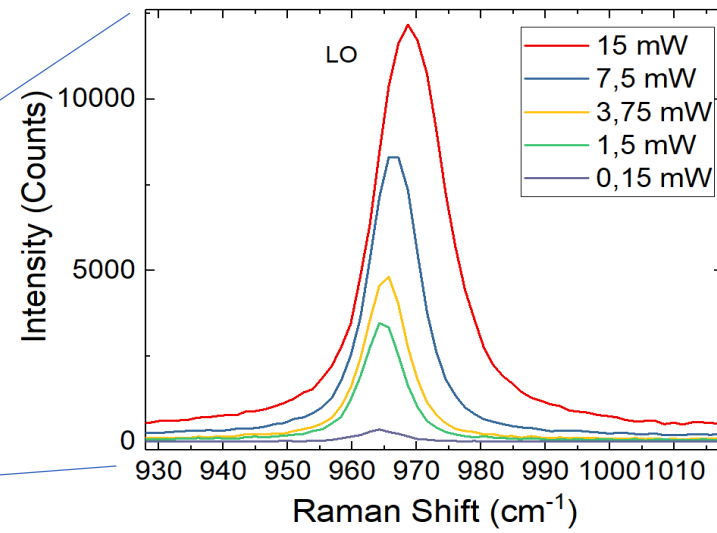
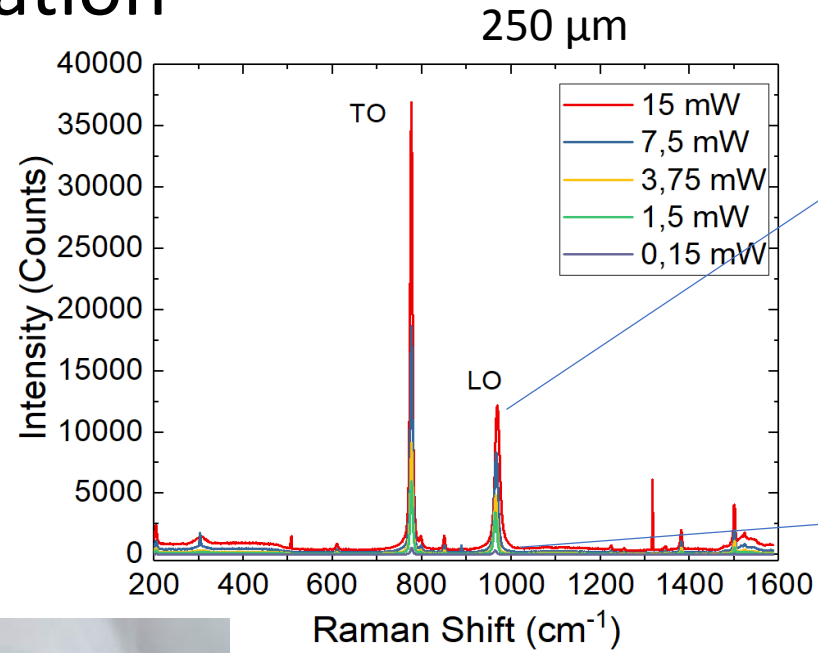


4H PL signal



Characterization

Raman spectra

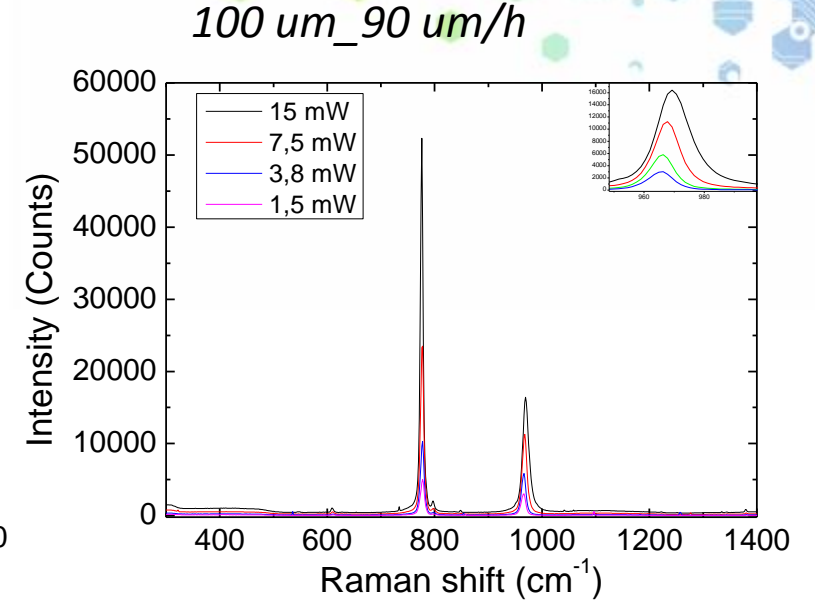
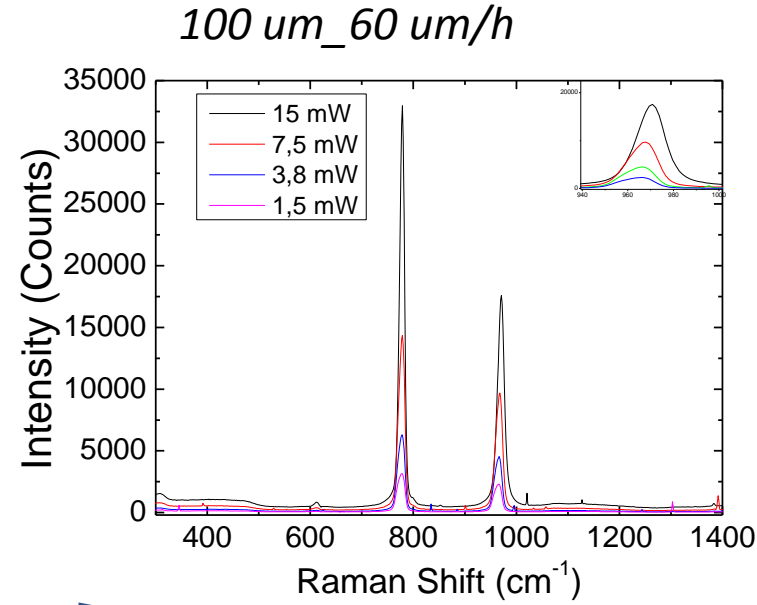
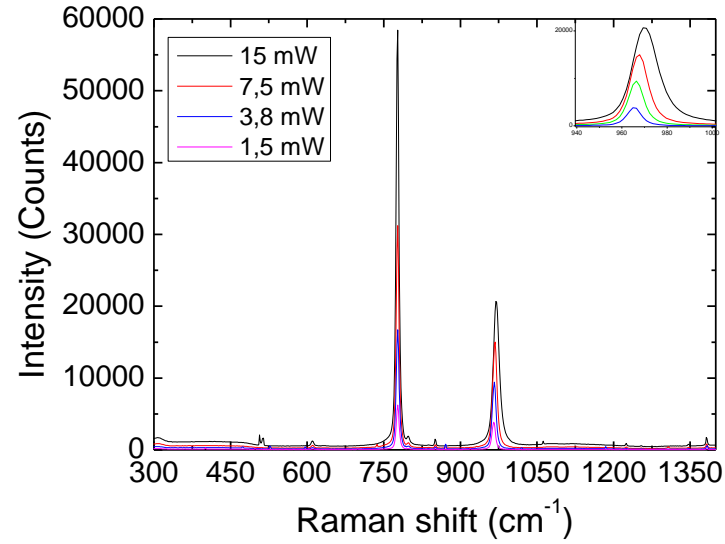


Laser Power increase

- Matrix: 5x2 and 4x4
- Laser: He-Cd 325nm
- Laser power: 15-7,5-3,8-1,5-0,15 mW
- Objective 40x
- Acquisition time= 12s
- Spot laser radius= 4,5 micron

Characterization

Raman spectra



Laser Power increase

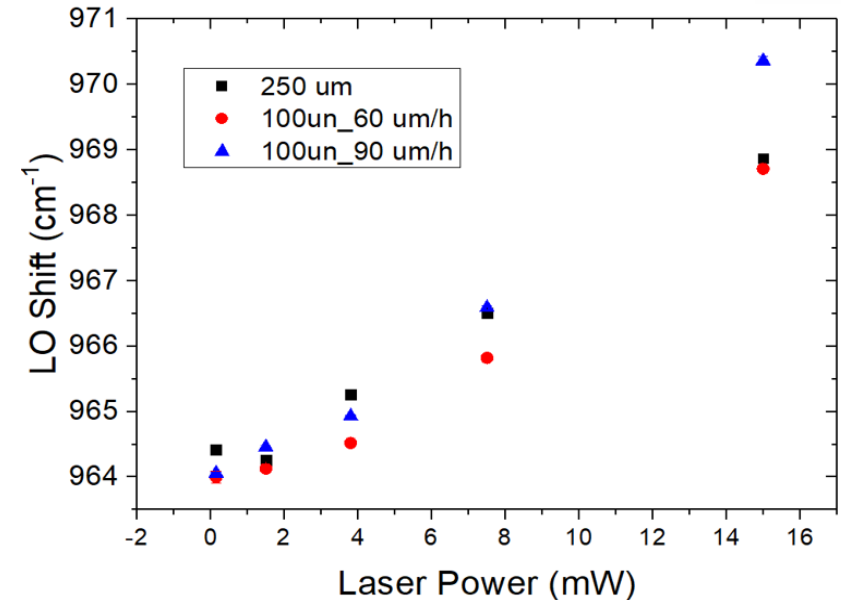
$$\omega_P^2 = \frac{4\pi n e^2}{\epsilon_0 \epsilon_\infty m^*} \rightarrow n$$

$$\gamma_p = \frac{e}{m^* \mu} \rightarrow \mu$$

$$G = \Phi \alpha e^{\alpha x}$$

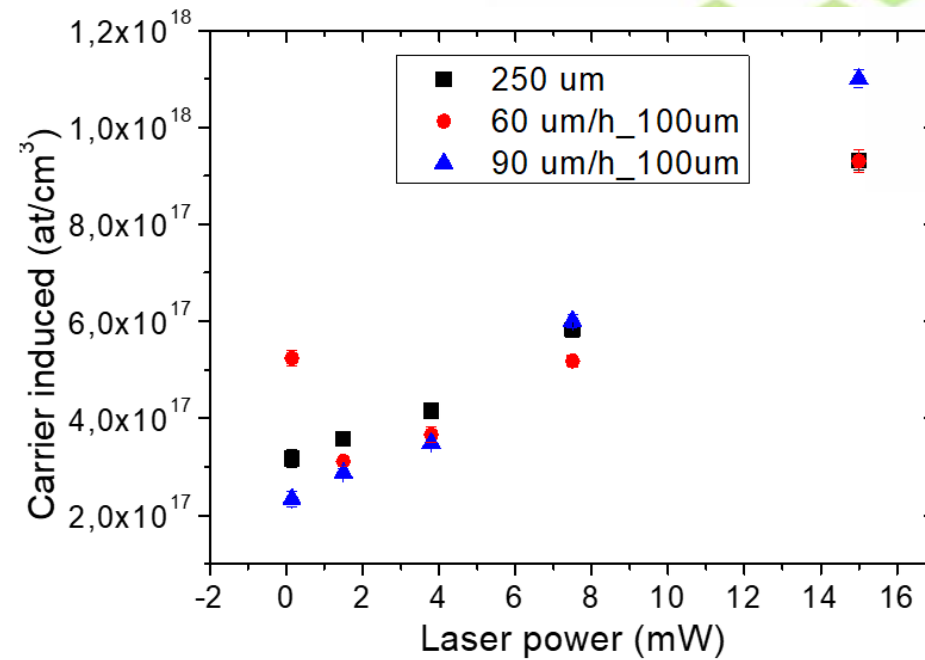
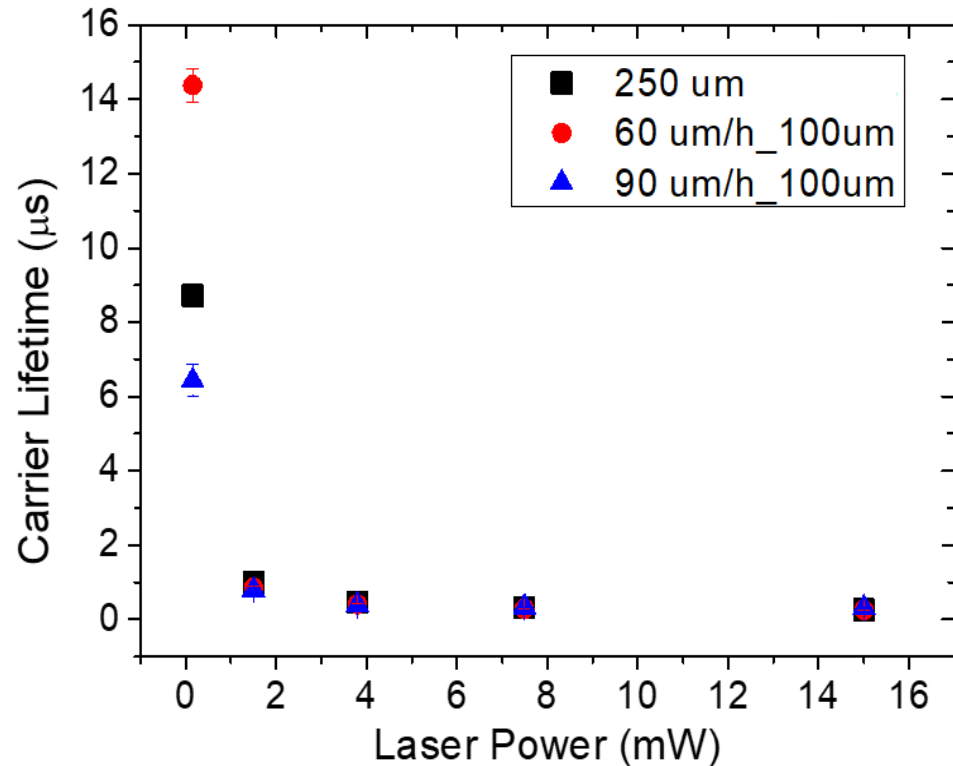
$$U = G = n - n_0 / \tau$$

M. Chafai et al., J. Appl. Phys. 90, 5211 (2001).



Characterization

Carrier lifetime post PL



Auger recombination mechanism

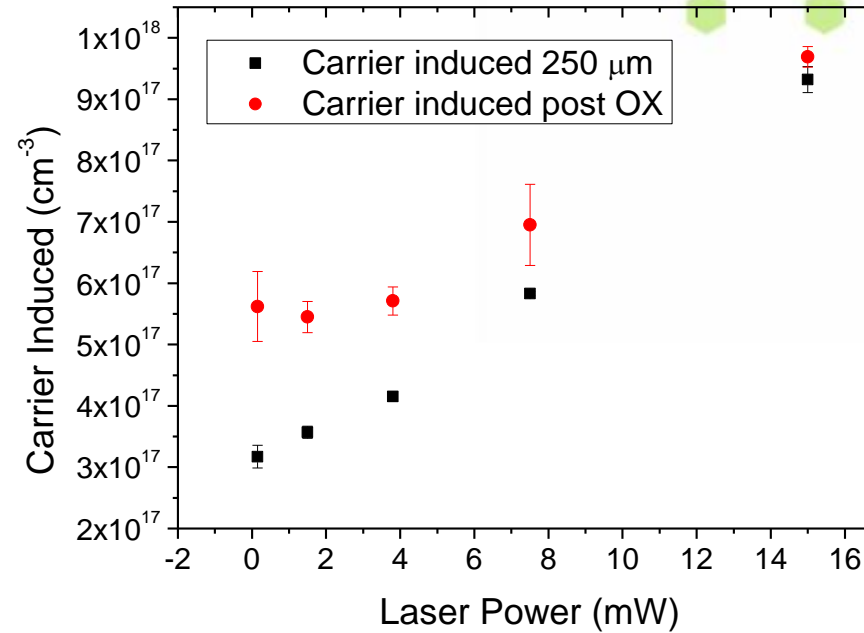
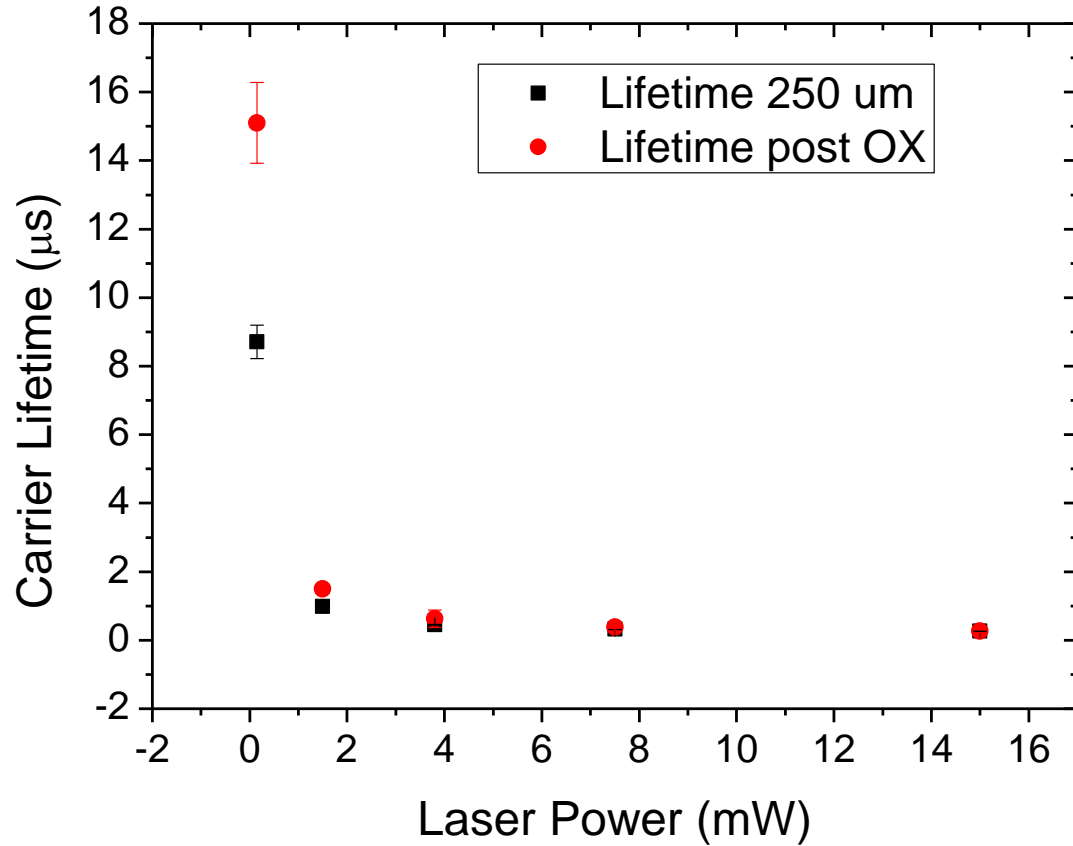


Potenza (mW)	250 μm τ (μs)_PL	60 μm/h τ (μs)_PL	90 μm/h τ (μs)_PL
0,15	8,71	14,38	6,43
1,5	0,98	0,85	0,80
3,8	0,45	0,40	0,38
7,5	0,32	0,28	0,33
15	0,26	0,25	0,30

Oxidation process

Carrier lifetime

- 1400°C - 48h



<i>Potenza (mW)</i>	<i>250 μm τ (μs)_No Ox</i>	<i>250 μm τ (μs)_postOX</i>
0,15	8,71	15,10
1,5	0,98	1,50
3,8	0,45	0,63
7,5	0,32	0,38
15	0,26	0,27

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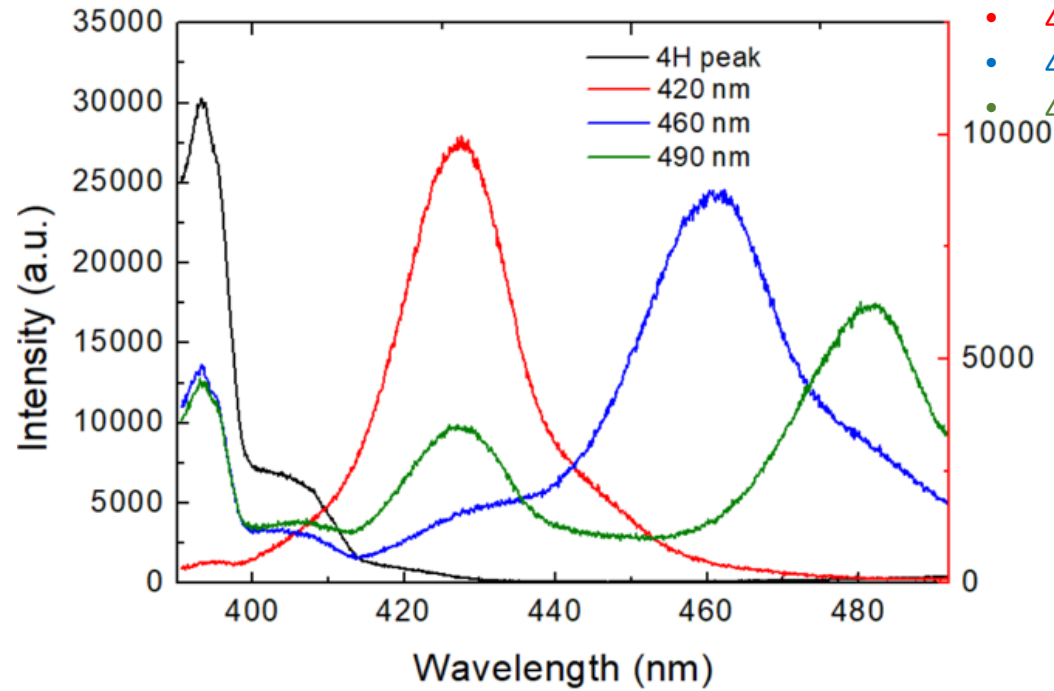
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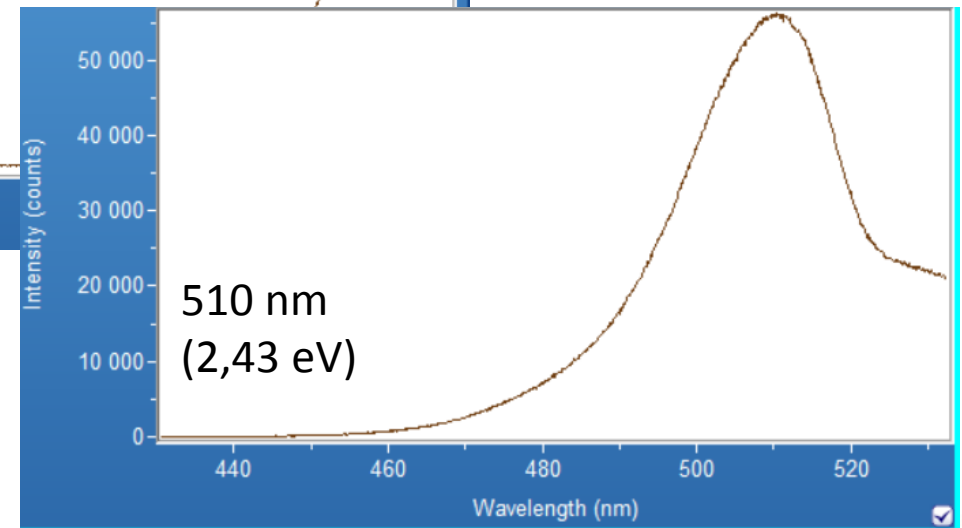
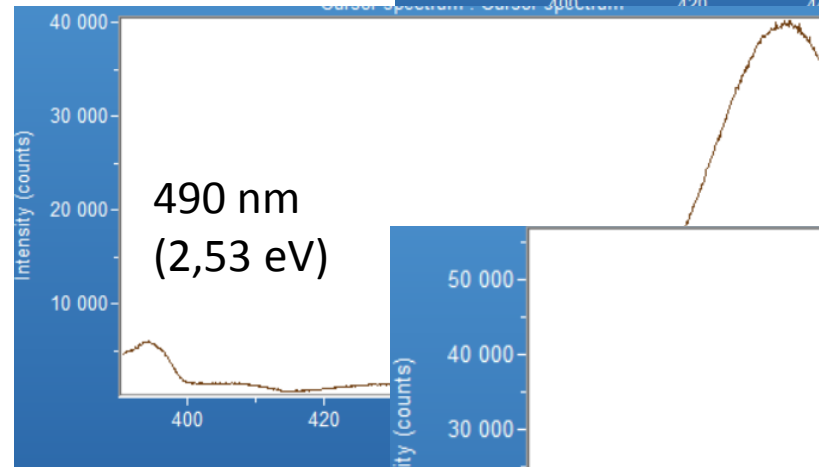
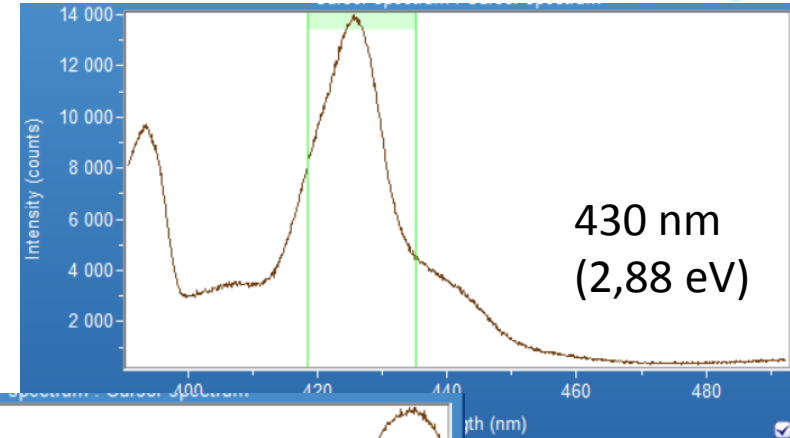
Conclusion

Defect Study

Influence on carrier lifetime

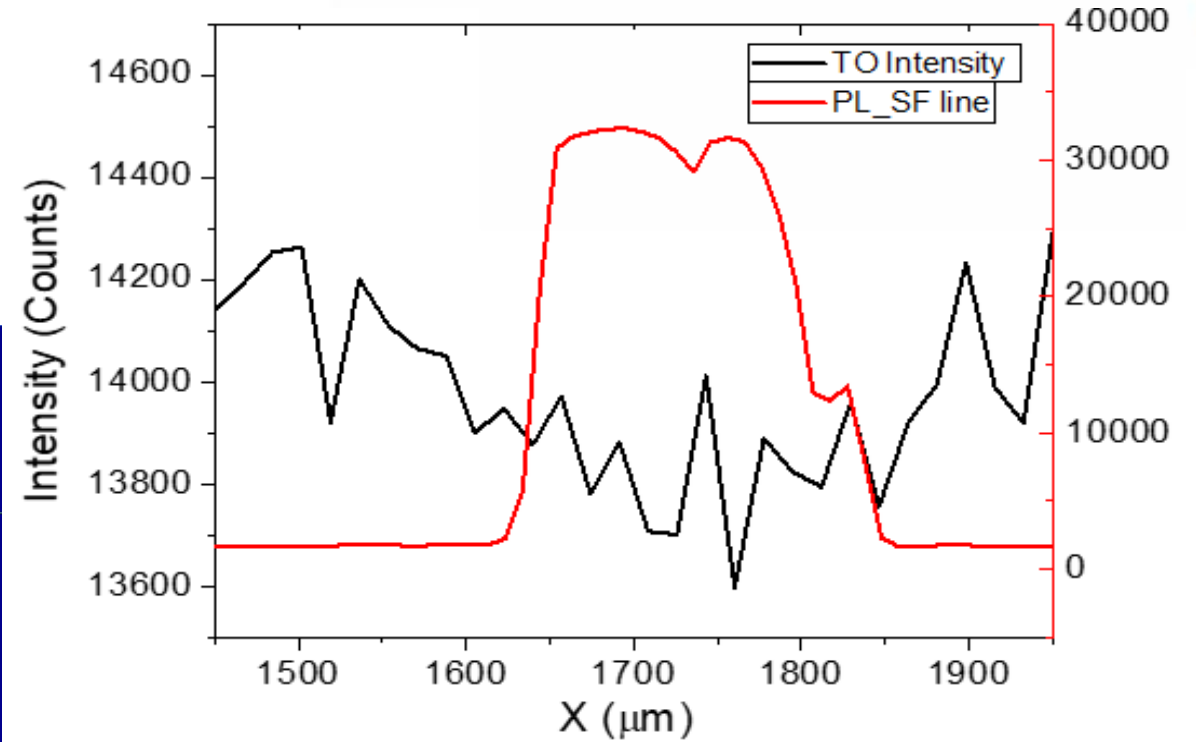
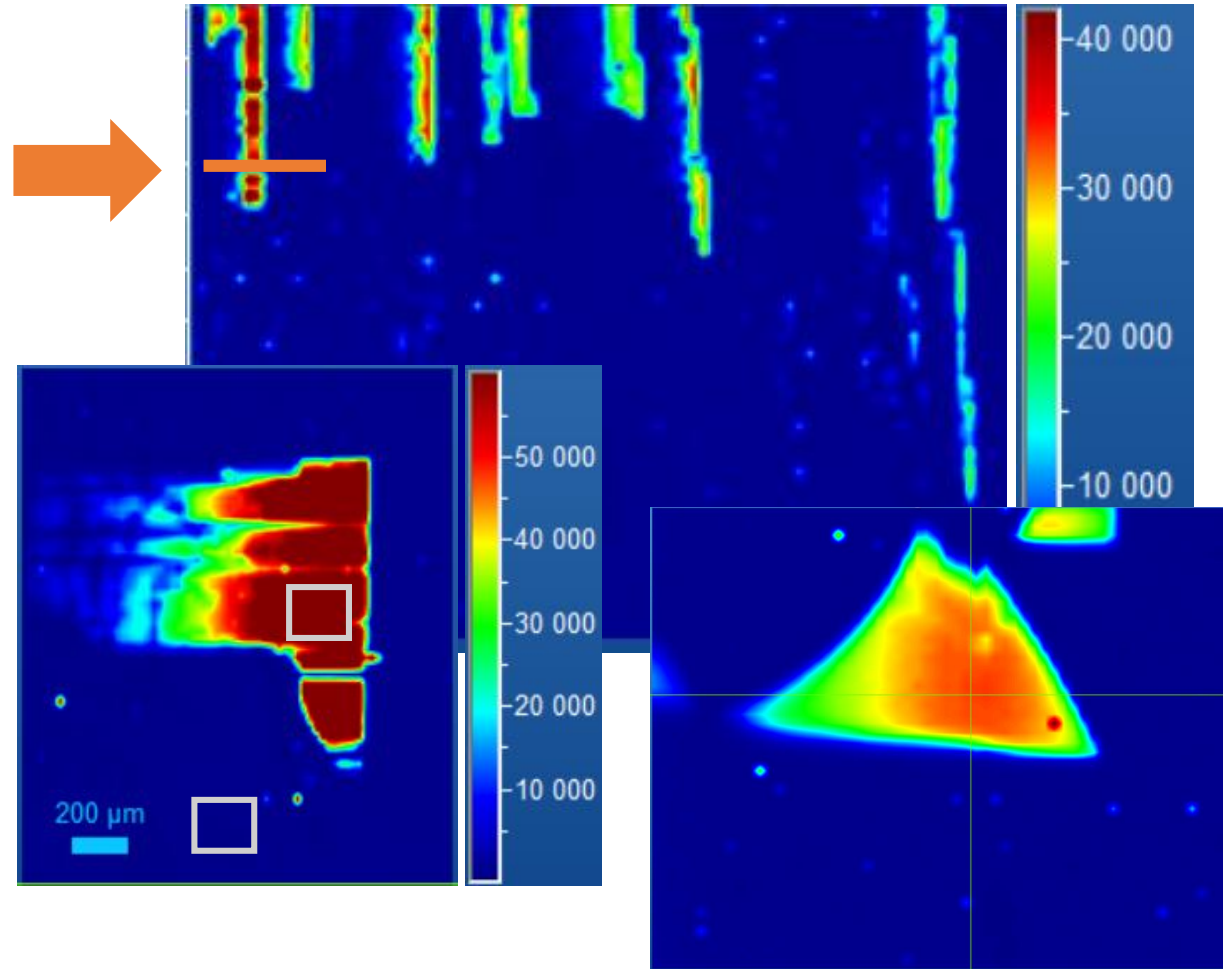


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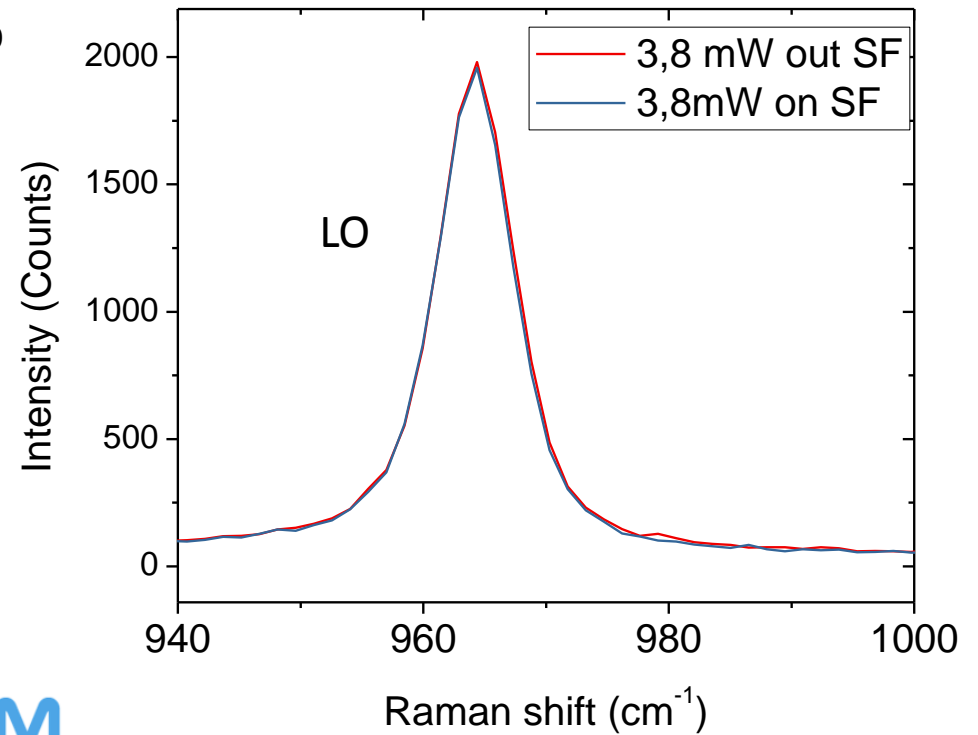
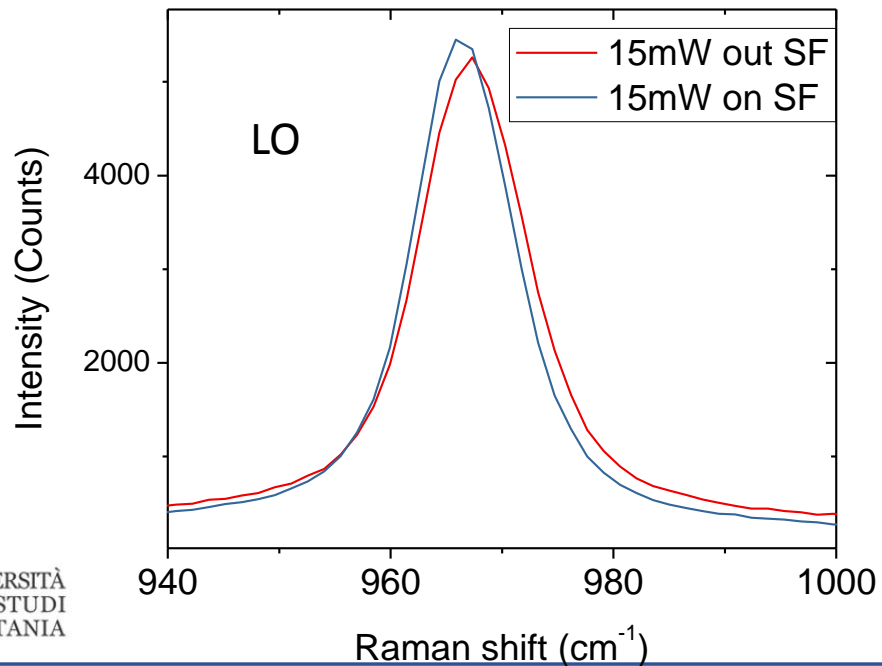
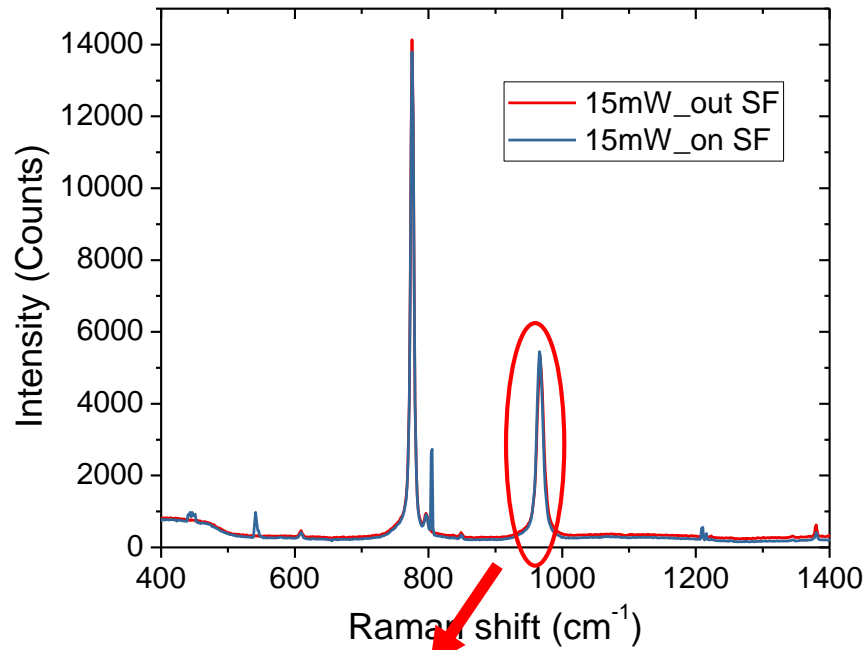
Defect Study

430 nm (2,88 eV)



Defect Study

430 nm (2,88 eV)



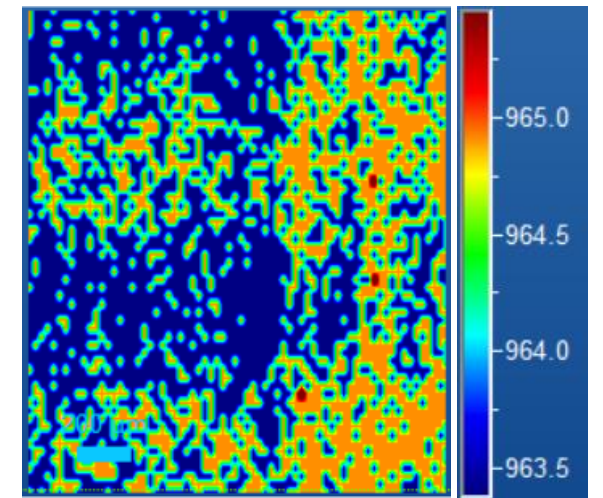
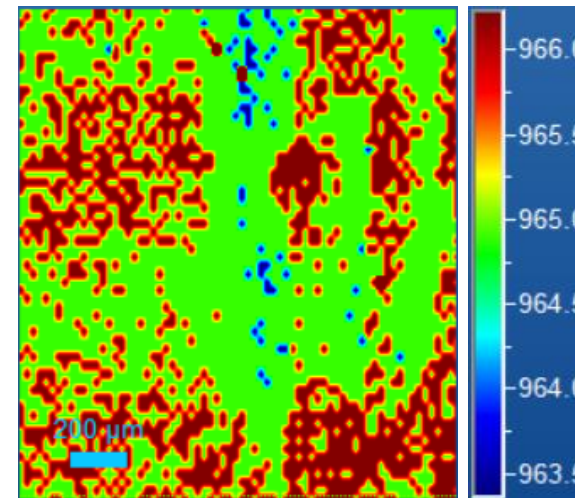
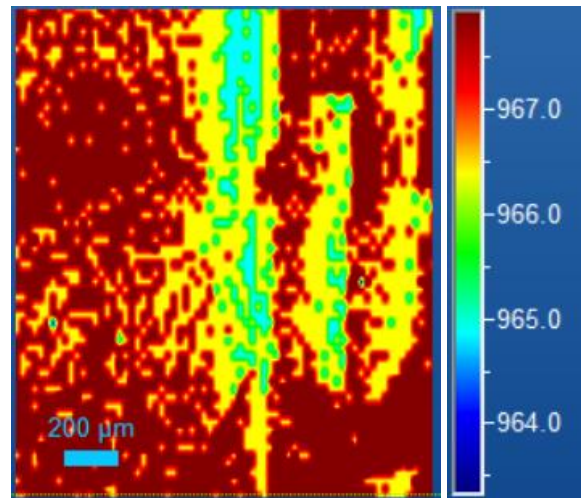
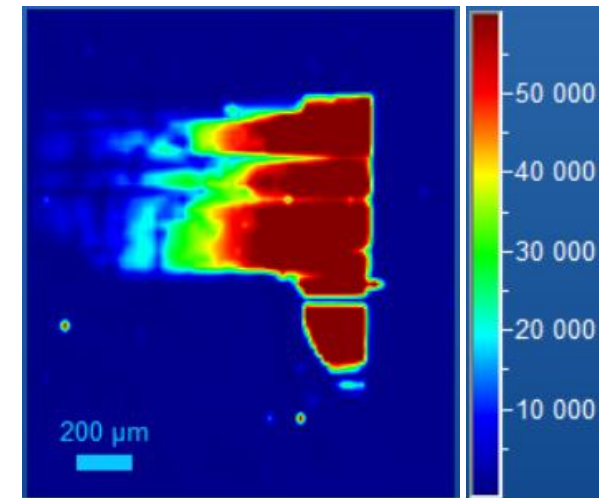
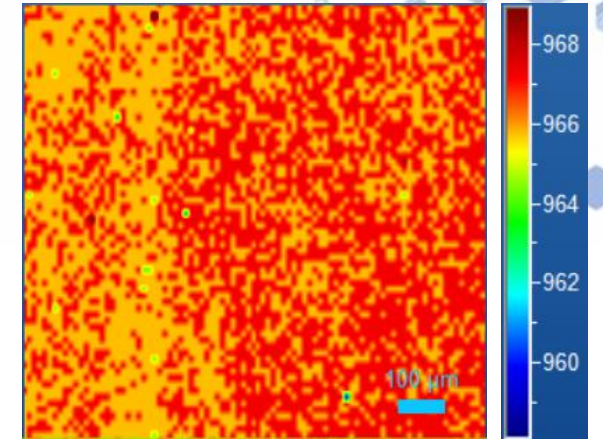
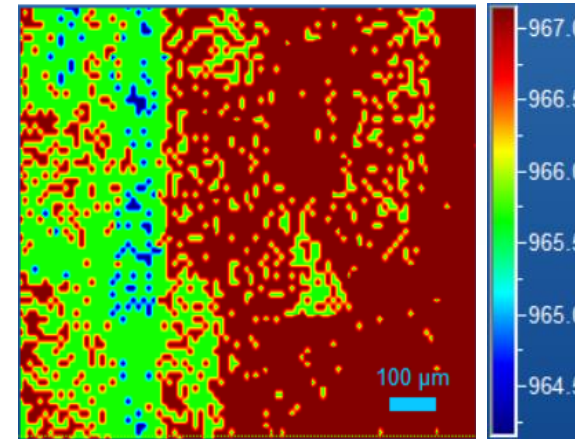
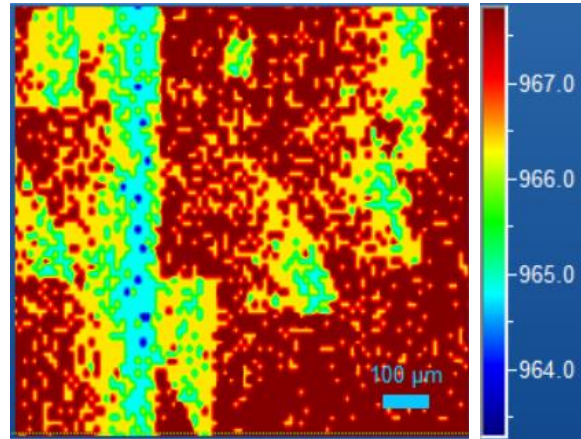
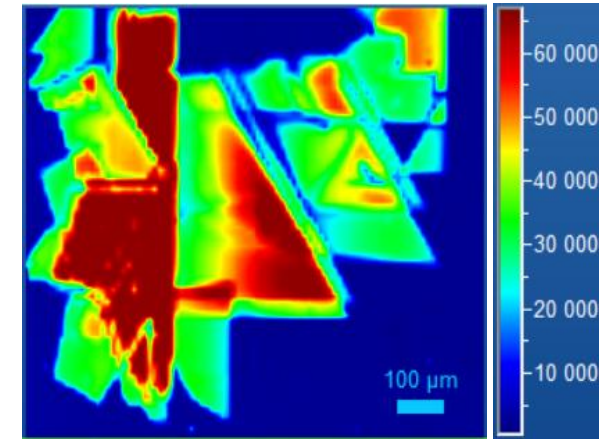
Defect Study

430 nm isolated

15 mW

7,5 mW

3,8 mW



490 nm isolated

15 mW

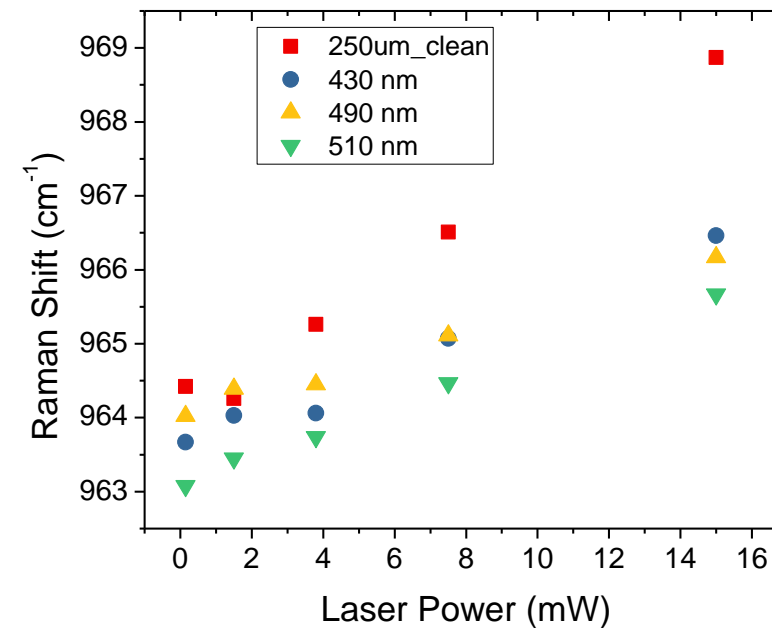
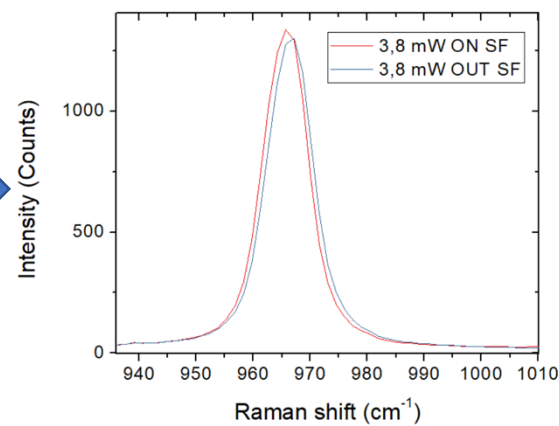
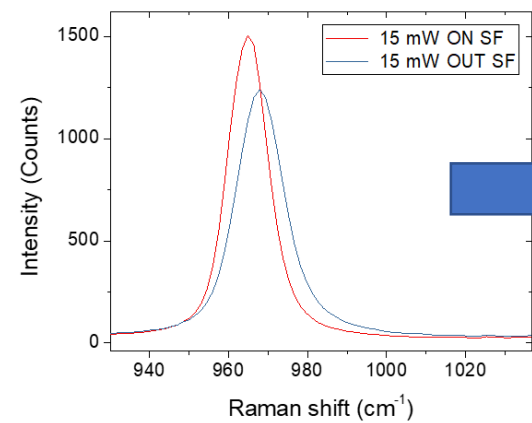
7,5 mW

3,8 mW

Defect Study

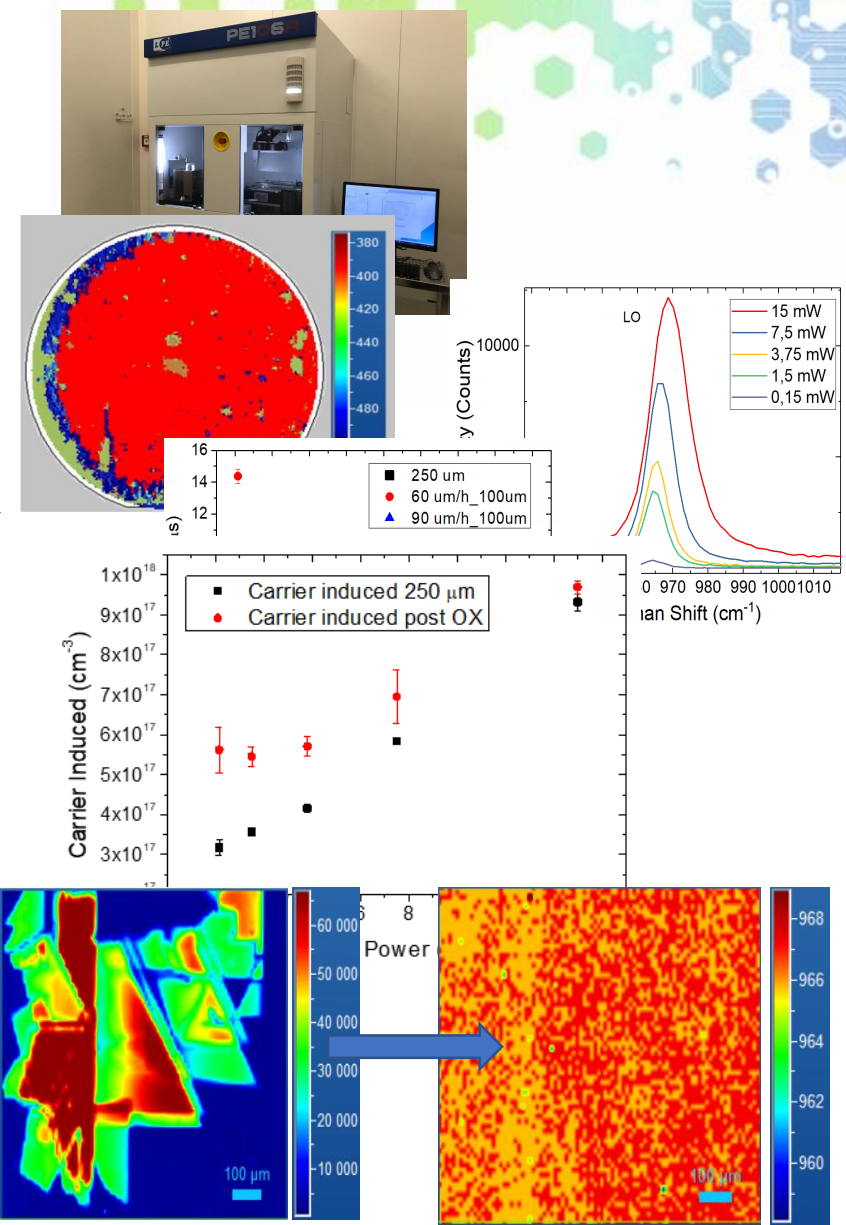
	15 mW		7,5 mW		3,8 mW		1,5 mW		0,15 mW	
Far SF	0,26 μ s		0,32 μ s		0,45 μ s		0,98 μ s		8,71 μ s	
	On SF (μ s)	Out SF (μ s)	On SF (μ s)	Out SF (μ s)	On SF (μ s)	Out SF (μ s)	On SF (μ s)	Out SF (μ s)	On SF (μ s)	Out SF (μ s)
430	0,18	0,21	0,23	0,25	0,31	0,32	0,68	0,68	5,41	5,41
490	0,14	0,23	0,17	0,27	0,23	0,29	0,49	0,49	3,46	3,46
510	0,15	0,22	0,17	0,25	0,24	0,30	0,48	0,55	4,43	4,43

← Clean AREA



Conclusion

- Study of the epitaxial growth process →
- Carrier lifetime and carrier density evaluation →
- Oxidation process 1400°C - 48h →
- Influence of the defects on carrier lifetime →



Acknowledgment

Dott. La Via Francesco
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Laura Meda
Miriam Parisi



**THANKS FOR YOUR
KIND ATTENTION**



